

Vishay Siliconix

Document Number: 75612

0.3 pC Charge Injection, 100 pA Leakage CMOS \pm 5 V / 5 V / 3 V 4-Channel Multiplexer

DESCRIPTION

The DG604E is an analog 4-channel CMOS, multiplexer, designed to operate from a +3 V to +16 V single supply, or from \pm 3 V to \pm 8 V, dual supplies. The DG604E is fully specified at +3 V, +5 V and \pm 5 V.

The DG604E offers ultralow charge injection less than $\pm 0.4 \text{ pC}$ over the entire signal range and leakage currents of 16 pA typical at 25 °C. It offers on resistance of 64 Ω typ., and low parasitic capacitance of 4.2 pF source off, and 11 pF Drain on. The part is ideal for analog front end, data acquisition and sample and hold designs providing fast and precision signal switching.

The DG604E switches one of four inputs to a common output as determined by the 3-bit binary address lines: A0, A1, and EN. Each switch conducts equally well in both directions when on, blocks input voltages up to the supply level when off, and exhibits break before make switching action.

All control logic inputs have guaranteed 2 V logic high limits when operating from +5 V or ± 5 V supplies and 1.4 V when operating from a 3 V supply.

The DG604E operating temperature range is specified from -40 °C to +125 °C. It is available in 14 lead TSSOP and the space saving 1.8 mm x 2.6 mm miniQFN package.

FEATURES

• Ultra low charge injection (less than ± 0.4 pC, typ. over the full analog signal range)



COMPLIANT

HALOGEN

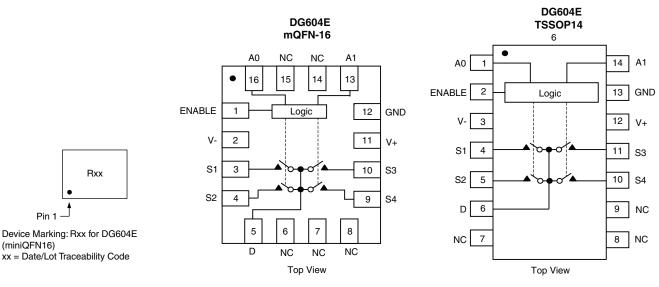
FREE

- Leakage current < 0.5 nA max. at 85 °C (for DG604EEQ-T1-GE4)
- Low switch capacitance (C_{S(off)}, 4.2 pF typ.)
- Fully specified with single supply operation at 3 V, 5 V, and dual supplies at ± 5 V
- CMOS / TTL compatible
- 414 MHz, -3 dB bandwidth
- Excellent isolation and crosstalk performance (typ. > -60 dB at 10 MHz)
- Fully specified from -40 °C to +85 °C and -40 °C to +125 °C
- 14 pin TSSOP and 16 pin miniQFN package (1.8 mm x 2.6 mm)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Data acquisition systems
- Medical instruments
- Precision instruments
- Communications systems
- Automated test equipment
- Sample and hold circuit
- Relay replacement

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



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1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u>

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| ENABLE | | | ON SWITCHES | | | | |
|--------|----|----|-------------------|--|--|--|--|
| INPUT | A1 | A0 | DG604E | | | | |
| L | Х | Х | All switches open | | | | |
| Н | L | L | D to S1 | | | | |
| Н | L | Н | D to S2 | | | | |
| Н | Н | L | D to S3 | | | | |
| Н | Н | Н | D to S4 | | | | |

| ORDERING INFORMATION | | | | | |
|----------------------|----------------|-----------------|--|--|--|
| TEMP. RANGE | PACKAGE | PART NUMBER | | | |
| -40 °C to +125 °C a | 14 pin TSSOP | DG604EEQ-T1-GE4 | | | |
| -40 0 10 +125 0 % | 16 pin miniQFN | DG604EEN-T1-GE4 | | | |

Note

a. -40 °C to +85 °C datasheet limits apply

| ABSOLUTE MAXIMUM RATINGS | $G(T_A = 25 \ ^{\circ}C, \text{ unless otherw})$ | vise noted) | |
|--|--|---|------|
| PARAMETER | | LIMIT | UNIT |
| V+ to V- | | -0.3 to +18 | |
| GND to V- | | 18 | |
| V _S , V _D | | (V-) -0.3 to (V+) + 0.3 or 30 mA, whichever occurs first | V |
| Digital inputs ^a | | (GND) -0.3 to (V+) + 0.3 | |
| Continuous current (any terminal) | | 30 | |
| Peak current, S or D (pulsed 1 ms, 10 % duty | S or D (pulsed 1 ms, 10 % duty cycle) 100 | | — mA |
| Storage temperature | | -65 to +150 | °C |
| Dower discinction (neckage) b | 14 pin TSSOP ^c | 450 | |
| Power dissipation (package) ^b | 16 pin miniQFN ^{d, e} | 525 | mW |
| Thermal registeres (neckage) b | 14 pin TSSOP | 178 | °C/W |
| Thermal resistance (package) ^b | 16 pin miniQFN | 152 | C/W |
| ESED / HBM | EIA / JESD22-A114-A 2K | | V |
| ESD / CDM | EIA / JESD22-C101-A | 1K | V |
| Latch up | JESD78 | 300 | mA |

Notes

a. Signals on S_X, D_X, or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings

b. All leads welded or soldered to PC board

c. Derate 5.6 mW/°C above 70 °C

d. Derate 6.6 mW/°C above 70 °C

e. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



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| | | TEST CONDITIONS | | | -40 °C to | 0 +125 °C | -40 °C t | o +85 °C | |
|---|-----------------------|--|--------------------|--------------|-------------------|-----------|-------------------|----------|-----|
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 5 V, V- = -5 V V _{IN A0, A1, AND ENABLE} = 2 V, 0.8 V ^a | TEMP. ^b | TYP.℃ | MIN. ^d | MAX. d | MIN. ^d | MAX. d | UNI |
| Analog Switch | | VIN AU, A1, AND ENABLE – 2 V, 0.0 V | | | | | | | |
| Analog signal range ^e | V _{ANALOG} | | Full | - | -5 | 5 | -5 | 5 | V |
| 0000 | ♥ ANALUG | | Room | 64 | - | 101 | - | 101 | • |
| Drain-source On-resistance | R _{DS(on)} | $I_{S} = 1 \text{ mA}, V_{D} = -3 \text{ V}, 0 \text{ V}, +3 \text{ V}$ | Full | - | _ | 135 | _ | 119 | |
| | | | Room | 0.5 | - | 5 | - | 5 | |
| On-resistance match | $\Delta R_{DS(on)}$ | $I_{S} = 1 \text{ mA}, V_{D} = \pm 3 \text{ V}$ | Full | - | _ | 7 | _ | 6 | Ω |
| | | | Room | 15 | - | 20 | _ | 20 | - |
| On-resistance flatness | R _{flat(on)} | I_{S} = 1 mA, V_{D} = -3 V, 0 V, +3 V | Full | 10 | _ | 25 | _ | 23 | - |
| | | | Room | ± 0.003 | -0.1 | 0.1 | -0.1 | 0.1 | |
| Switch off | I _{S(off)} | | Full | ± 0.005 | -18 | 18 | -0.1 | 0.1 | |
| leakage current | | $V_{+} = 5.5 V, V_{-} = -5.5 V$ $V_{D} = \pm 4.5 V, V_{S} = \mp 4.5 V$ | Room | - ± 0.009 | -18 | 0.1 | -0.5 | 0.5 | |
| (for 14 pin TSSOP) | I _{D(off)} | | Full | ± 0.009 | -0.1 | 18 | -0.1 | 0.1 | |
| Quitab an | | | - | | - | - | | | - |
| Switch on leakage current | I _{D(on)} | $V_{+} = 5.5 V, V_{-} = -5.5 V,$ | Room | ± 0.016 | -0.1 | 0.1 | -0.1 | 0.1 | - |
| (for 14 pin TSSOP) | D(OII) | $V_D = V_S = \pm 4.5 \text{ V}$ | Full | - | -18 | 18 | -0.5 | 0.5 | nA |
| | | | Room | ± 0.003 | -1 | 1 | -1 | 1 | |
| Switch off | IS(off) | V+ = 5.5 V, V- = -5.5 V | Full | - | -18 | 18 | -2 | 2 | 1 |
| leakage current (for 16 pin miniQFN) | | $V_D=\pm~4.5~V,~V_S=\mp~4.5~V$ | Room | ± 0.009 | -1 | 1 | -1 | 1 | |
| | I _{D(off)} | | Full | - | -18 | 18 | -2 | 2 | |
| Switch on | | V+ = 5.5 V, V- = -5.5 V, | Room | ± 0.016 | -1 | 1 | -1 | 1 | 1 |
| leakage current (for 16 pin miniQFN) | I _{D(on)} | $V_{\rm D} = V_{\rm S} = \pm 4.5 \text{ V}$ | Full | - | -18 | 18 | -2 | 2 | |
| Digital Control | | | | | | | | | |
| Input current, V _{IN} low | IIL | $V_{IN A0, A1 and ENABLE}$ Under test = 0.8 V | Full | 0.00001 | -0.1 | 0.1 | -0.1 | 0.1 | μA |
| Input current, V _{IN} high | I _{IH} | V _{IN A0, A1 and ENABLE} Under test = 2 V | Full | 0.00001 | -0.1 | 0.1 | -0.1 | 0.1 | μΑ |
| Input capacitance | CIN | f = 1 MHz | Room | 5 | - | - | - | - | pF |
| Dynamic Characteristi | cs | | | | | | | | |
| Turneitien time | 1 | $V_{S(CLOSE)} = 3 V, V_{S(OPEN)} = 0 V,$ | Room | 29 | - | 67 | - | 67 | |
| Transition time | t _{TRANS} | $R_L = 300 \Omega, C_L = 35 pF$ | Full | - | - | 87 | - | 82 | 1 |
| T | | | Room | 26 | - | 54 | - | 54 | |
| Turn-on time | t _{ON} | $R_L = 300 \ \Omega, \ C_L = 35 \ pF$ | Full | - | - | 61 | - | 58 | |
| T | | $V_{\rm S} = \pm 3 \rm V$ | Room | 22 | - | 52 | - | 52 | ns |
| Turn-off time | t _{OFF} | | Full | - | - | 70 | - | 57 | 1 |
| Break-before-make | | V _S = 3 V | Room | 7 | - | - | - | - | 1 |
| time | t _{BBM} | $R_{L} = 300 \Omega, C_{L} = 35 pF$ | Full | - | 2 | - | 2 | - | 1 |
| Charge injection ^e | Q _{INJ} | $V_{GEN} = 0 V$, $R_{GEN} = 0 \Omega$, $C_L = 1 nF$ | Room | -0.3 | - | - | - | - | pC |
| Off isolation ^e | OIRR | $R_{L} = 50 \Omega$, $C_{L} = 5 pF$, f = 10 MHz | Room | -67 | - | - | - | - | dB |
| Bandwidth ^e | BW | $R_L = 50 \Omega$, $C_L = 5 pF$ | Room | 414 | - | - | - | - | MH |
| Channel-to-channel crosstalk ^e | X _{TALK} | $R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$ | Room | -65 | - | - | - | - | dE |
| Source off capacitance e | C _{S(off)} | | Room | 4.2 | - | - | - | - | |
| Drain off capacitance e | C _{D(off)} | f = 1 MHz | Room | 6.8 | - | - | - | - | pF |
| Drain on capacitance ^e | C _{D(on)} | 1 | Room | 11 | - | _ | - | _ | , " |

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| SPECIFICATIONS | 6 FOR DI | JAL SUPPLIES (V+ = 5 V, V | /- = -5 V |) | | | | | |
|----------------------|----------|--|--------------------|---------|-------------------|-------------------|-------------------|----------|------|
| | | TEST CONDITIONS | | | -40 °C to | +125 °C | -40 °C to | o +85 °C | |
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 5 V, V- = -5 V V _{IN A0, A1, AND ENABLE} = 2 V, 0.8 V ^a | TEMP. ^b | TYP. ° | MIN. ^d | MAX. ^d | MIN. ^d | MAX. d | UNIT |
| Power Supply | | | | | | | | | |
| Power supply current | I+ | | Room | 0.0004 | - | 0.5 | - | 0.5 | |
| Tower supply current | 1+ | | Full | - | - | 1 | - | 1 | |
| Negative supply | 1- | $V_{IN} = 0 V \text{ or } V +$ | Room | -0.0004 | -0.5 | - | -0.5 | - | μA |
| current | 1- | | Full | - | -1 | - | -1 | - | μA |
| Ground current | Le.ue | | Room | -0.0004 | -0.5 | - | -0.5 | - | |
| | IGND | | Full | - | -1 | - | -1 | - | |

Notes

a. Signals on S_X, D_X, or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings

b. All leads welded or soldered to PC board

c. Derate 5.6 mW/°C above 70 °C

d. Derate 6.6 mW/°C above 70 °C

e. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



| | | TEST CONDITIONS | | | -40 °C to | o +125 °C | -40 °C t | o +85 °C | |
|--|-----------------------|---|--------------------|---------|-------------------|-----------|-------------------|----------|-----|
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 5 V, V- = 0 V V _{IN A0, A1, AND ENABLE} = 2 V, 0.8 V ^a | TEMP. ^b | ۲YP. ۵ | MIN. ^d | MAX. d | MIN. ^d | MAX. d | UNI |
| Analog Switch | | | | | | | | | |
| Analog signal range ^e | V _{ANALOG} | | Full | - | 0 | 5 | 0 | 5 | V |
| Drain-source | Baar | I _S = 1 mA, V _D = +3.5 V | Room | 134 | - | 181 | - | 181 | |
| On-resistance | R _{DS(on)} | IS = 1 IIIA, VD = +3.3 V | Full | - | - | 232 | - | 208 | |
| On-resistance match | $\Delta R_{DS(on)}$ | I _S = 1 mA, V _D = +3.5 V | Room | 1.4 | - | 7 | - | 7 | Ω |
| | 21 (DS(0H) | 13 - 1 m , 10 - 10.0 1 | Full | - | - | 9 | - | 8 | |
| On-resistance flatness | R _{flat(on)} | I _S = 1 mA, V _D = 0 V, +3.5 V | Room | 36 | - | 50 | - | 50 | |
| | · · ·ilat(OII) | | Full | - | - | 54 | - | 52 | |
| Outlack off | I _{S(off)} | | Room | ± 0.002 | -0.1 | 0.1 | -0.1 | 0.1 | |
| Switch off leakage current | -3(011) | $V_{+} = 5.5 V, V_{-} = 0 V$ $V_{D} = 1 V / 4.5 V,$ | Full | - | -18 | 18 | -0.5 | 0.5 | |
| (for 14 pin TSSOP) | I _{D(off)} | $V_{\rm S} = 4.5 {\rm V} / 1 {\rm V}$ | Room | ± 0.007 | -0.1 | 0.1 | -0.1 | 0.1 | |
| | D(011) | | Full | - | -18 | 18 | -0.5 | 0.5 | |
| Switch on leakage current | | V+ = 5.5 V, V- = 0 V | Room | ± 0.01 | -0.1 | 0.1 | -0.1 | 0.1 | |
| (for 14 pin TSSOP) | I _{D(on)} | $V_{D} = V_{S} = 1 \text{ V} / 4.5 \text{ V}$ | Full | - | -18 | 18 | -0.5 | 0.5 | |
| (I) | | | Room | ± 0.002 | -1 | 1 | -1 | 1 | nA |
| Switch off | I _{S(off)} | V+ = 5.5 V, V- = 0 V | Full | - | -18 | 18 | -2 | 2 | |
| leakage current (for 16 pin miniQFN) | | V _D = 1 V / 4.5 V, V _S = 4.5 V / 1 V | Room | ± 0.007 | -1 | 1 | -1 | 1 | |
| | I _{D(off)} | vs = 4.0 v / 1 v | Full | - | -18 | 18 | -2 | 2 | |
| Switch on | | V+ = 5.5 V, V- = 0 V, | Room | ± 0.01 | -1 | 1 | -1 | 1 | |
| leakage current (for 16 pin miniQFN) | I _{D(on)} | $V_{\rm D} = V_{\rm S} = 1 \text{ V} / 4.5 \text{ V}$ | Full | - | -18 | 18 | -2 | 2 | |
| Digital Control | 1 | | | 1 | 1 | | | 1 | 1 |
| Input current, V _{IN} low | IIL | V _{IN A0, A1, and ENABLE} Under test = 0.8 V | Full | 0.00001 | -0.1 | 0.1 | -0.1 | 0.1 | μA |
| Input current, V _{IN} high | I _{IH} | V _{IN A0, A1, and ENABLE} Under test = 2 V | Full | 0.00001 | -0.1 | 0.1 | -0.1 | 0.1 | μ |
| Input capacitance | CIN | f = 1 MHz | Room | 5 | - | - | - | - | pF |
| Dynamic Characteristic | s | | | - | - | | | | |
| Transition time | t _{TRANS} | | Room | 47 | - | 70 | - | 70 | |
| | •TRANS | | Full | - | - | 116 | - | 91 | |
| Turn-on time | t _{ON} | $V_{S(CLOSE)} = 3 V, V_{S(OPEN)} = 0 V,$ | Room | 32 | - | 52 | - | 52 | |
| | -ON | $R_L = 300 \Omega$, $C_L = 35 pF$ | Full | - | - | 63 | - | 57 | ns |
| Turn-off time | t _{OFF} | | Room | 26 | - | 46 | - | 46 | |
| | -011 | | Full | - | - | 61 | - | 55 | |
| Break-before-make-time | t _{BMM} | | Room | 22 | - | - | - | - | |
| | | | Full | - | 3 | - | 3 | - | |
| Charge injection e | Q _{INJ} | $C_L = 1 \text{ nF}, R_{GEN} = 0 \Omega, V_{GEN} = 0 V$ | Full | -0.03 | - | - | - | - | рС |
| Off-isolation ^e | OIRR | | Room | -66 | - | - | - | - | |
| Channel-to-channel crosstalk ^e | X _{TALK} | f = 10 MHz, R_L = 50 Ω , C_L = 5 pF | Room | -64 | - | - | - | - | dB |
| Bandwidth ^e | BW | $R_L = 50 \ \Omega, \ C_L = 5 \ pF$ | Room | 358 | - | - | - | - | MH |
| Source off capacitance e | C _{S(off)} | | | 4.4 | - | - | - | - | |
| Drain off capacitance ^e | C _{D(off)} | f = 1 MHz | Room | 7.3 | - | - | - | - | pF |
| Drain on capacitance e | C _{D(on)} | | | 12 | - | - | - | - | |

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| SPECIFICATIONS | FOR SIN | IGLE SUPPLY (V+ = 5 V , V- | - = 0 V) | | | | | | |
|-------------------------|---------|---|--------------------|---------|-------------------|-------------------|-------------------|----------|------|
| | | TEST CONDITIONS | | | -40 °C to | +125 °C | -40 °C to | o +85 °C | |
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 5 V, V- = 0 V V _{IN A0, A1, AND ENABLE} = 2 V, 0.8 V ^a | TEMP. ^b | TYP. ° | MIN. ^d | MAX. ^d | MIN. ^d | MAX. d | UNIT |
| Power Supply | | | | | | | | | |
| Power supply current | l+ | | Room | 0.0002 | - | 0.5 | - | 0.5 | |
| r ower supply current | 1+ | 1+ | Full | - | - | 1 | - | 1 | |
| Negative supply current | 1- | $V_{IN} = 0 V \text{ or } V +$ | Room | -0.0002 | -0.5 | - | -0.5 | - | |
| Negative supply current | 1- | | Full | - | -1 | - | -1 | - | μA |
| Ground current | 1 | | Room | -0.0002 | -0.5 | - | -0.5 | - | |
| | IGND | | Full | - | -1 | - | -1 | - | |

Notes

- a. Signals on S_X, D_X, or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings
- b. All leads welded or soldered to PC board
- c. Derate 5.6 mW/°C above 70 °C
- d. Derate 6.6 mW/°C above 70 °C
- e. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



| | | TEST CONDITIONS | | | -40 °C to | o +125 °C | -40 °C t | o +85 °C | |
|---|--------------------------|---|--------------------|----------|-------------------|-----------|----------|----------|------|
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 3 V, V- = 0 V V _{IN A0, A1, AND ENABLE} = 1.4 V, 0.6 V ^a | TEMP. ^b | TYP. ° | MIN. ^d | MAX. d | MIN. d | MAX. d | UNIT |
| Analog Switch | | | | • | | | | | |
| Analog signal range ^e | V _{ANALOG} | | Full | - | - | 3 | - | 3 | V |
| Drain-source | R _{DS(on)} | I _S = 1 mA, V _D = +1.5 V | Room | 319 | - | 416 | - | 416 | |
| On-resistance | US(on) | | Full | - | - | 478 | - | 453 | Ω |
| On-resistance match | $\Delta R_{DS(on)}$ | I _S = 1 mA, V _D = +1.5 V | Room | 7 | - | 15 | - | 15 | 22 |
| | 20(01) | | Full | - | - | 17 | - | 16 | |
| Switch off | I _{S(off)} | V+ = 3.3 V, V- = 0 V | Room | ± 0.001 | -0.1 | 0.1 | -0.1 | 0.1 | |
| leakage current | 0(011) | $V_{\rm P} = 3.5 V, V_{\rm P} = 0 V$ $V_{\rm D} = 1 V / 3 V,$ | Full | - | -18 | 18 | -0.5 | 0.5 | |
| (for 14 pin TSSOP) | I _{D(off)} | $V_{\rm S} = 3 {\rm V} / 1 {\rm V}$ | Room | ± 0.006 | -0.1 | 0.1 | -0.1 | 0.1 | |
| | 5(0.1) | | Full | - | -18 | 18 | -0.5 | 0.5 | |
| Switch on leakage current | lo() | V+ = 3.3 V, V- = 0 V | Room | ± 0.006 | -0.1 | 0.1 | -0.1 | 0.1 | |
| (for 14 pin TSSOP) | I _{D(on)} | $V_{\rm D} = V_{\rm S} = 1 \text{ V} / 3 \text{ V}$ | Full | - | -18 | 18 | -0.5 | 0.5 | nA |
| | | | Room | ± 0.001 | -1 | 1 | -1 | 1 | ПА |
| Switch off leakage current | I _{S(off)} | $V_{+} = 3.3 V, V_{-} = 0 V$ | Full | - | -18 | 18 | -2 | 2 | |
| (for 16 pin miniQFN) | | V _D = 1 V / 3 V, V _S = 3 V / 1 V | Room | ± 0.006 | -1 | 1 | -1 | 1 | |
| (****) | I _{D(off)} | 6 | Full | - | -18 | 18 | -2 | 2 | |
| Switch on | | V+ = 3.3 V, V- = 0 V, | Room | ± 0.006 | -1 | 1 | -1 | 1 | |
| leakage current (for 16 pin miniQFN) | I _{D(on)} | $V_{\rm D} = V_{\rm S} = 1 \text{ V} / 3 \text{ V}$ | Full | - | -18 | 18 | -2 | 2 | |
| Digital Control | | | | | | | | | |
| Input current, V _{IN} low | IIL | $V_{IN A0, A1 and ENABLE}$ under test = 0.6 V | Full | 0.00008 | -1 | 1 | -1 | 1 | μA |
| Input current, V_{IN} high | IIН | $V_{IN A0, A1 and ENABLE}$ under test = 1.4 V | Full | 0.000008 | -1 | 1 | -1 | 1 | μΑ |
| Input capacitance | C _{IN} | f = 1 MHz | Room | 5 | - | - | - | - | pF |
| Dynamic Characterist | ics | | | | | | | | - |
| Transition time | t _{TRANS} | | Room | 138 | - | 163 | - | 163 | |
| | THANS | | Full | - | - | 197 | - | 195 | |
| Turn-on time | t _{on} | $V_{S(CLOSE)} = 3 V, V_{S(OPEN)} = 0 V,$ | Room | 95 | - | 117 | - | 117 | |
| | 0.1 | $R_{L} = 300 \Omega, C_{L} = 35 \text{ pF}$ | Full | - | - | 145 | - | 135 | ns |
| Turn-off time | t _{OFF} | | Room | 55 | - | 76 | - | 76 | |
| | | | Full | - | - | 98 | - | 90 | |
| Break-before-make-time | t _{BMM} | | Room | 58 | - | - | - | - | |
| Charge injection e | 0 | C _L = 1 nF, R _{GEN} = 0 Ω, V _{GEN} = 0 V | Full Full | - 0.01 | - | - | 5 | - | рС |
| Off-isolation ^e | Q _{INJ} OIRR | $O_L = 1.111$, $H_{GEN} = 0.52$, $V_{GEN} = 0.V$ | Room | -66 | - | - | - | - | ρC |
| Channel-to-channel | | f = 10 MHz, R_L = 50 Ω , C_L = 5 pF | Room | -64 | | - | - | - | dB |
| crosstalk e | X _{TALK} | | | | | | | | |
| Bandwidth e | BW | $R_L = 50 \Omega, C_L = 5 pF$ | Room | 318 | - | - | - | - | MHz |
| Source off capacitance ^e | $C_{S(off)}$ | | Room | 4.6 | - | - | - | - | |
| Drain off capacitance ^e | C _{D(off)} | f = 1 MHz | Room | 7.7 | - | - | - | - | pF |
| Channel on capacitance ^e | C _{D(on)} | | Room | 12.6 | - | - | - | - | |

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DG604E

Vishay Siliconix

| SPECIFICATION | S FOR SI | NGLE SUPPLY (V+ = 3 V, V- | = 0 V) | | | | | | |
|-----------------------|----------|---|--------------------|---------|-------------------|-------------------|-------------------|----------|------|
| | | TEST CONDITIONS | | | -40 °C to |) +125 °C | -40 °C to | o +85 °C | |
| PARAMETER | SYMBOL | UNLESS OTHERWISE SPECIFIED V+ = 3 V, V- = 0 V V _{IN A0, A1, AND ENABLE} = 1.4 V, 0.6 V ^a | TEMP. ^b | TYP. ° | MIN. ^d | MAX. ^d | MIN. ^d | MAX. d | UNIT |
| Power Supply | | | | | | | | | |
| Power supply current | l+ | | Room | 0.0001 | - | 0.5 | - | 0.5 | |
| r ower supply current | I+ | 1+ | Full | - | - | 1 | - | 1 | |
| Negative supply | I- | $V_{IN} = 0 V \text{ or } V+$ | Room | -0.0001 | -0.5 | - | -0.5 | - | μA |
| current | 1- | $v_{\rm IN} = 0$ v or v+ | Full | - | -1 | - | -1 | - | μA |
| Ground current | la va | | Room | -0.0001 | -0.5 | - | -0.5 | - | |
| | IGND | | Full | - | -1 | - | -1 | - | |

Notes

- a. Signals on S_X, D_X, or IN_X exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings
- b. All leads welded or soldered to PC board

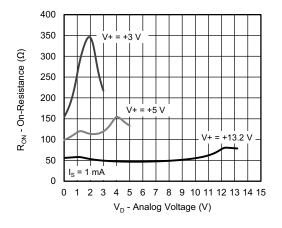
c. Derate 5.6 mW/°C above 70 °C

- d. Derate 6.6 mW/°C above 70 °C
- e. Manual soldering with iron is not recommended for leadless components. The miniQFN-16 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper lip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

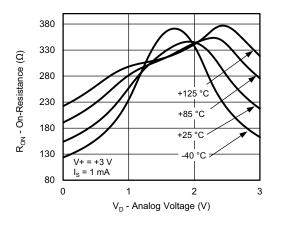
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



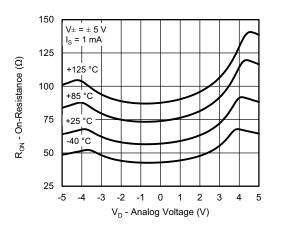
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



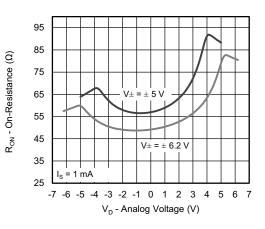
On-Resistance vs. V_D (Single Supply Voltage)



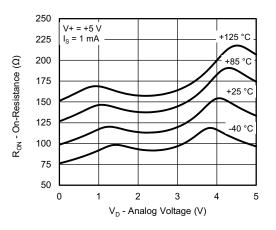
On-Resistance vs. Analog Voltage and Temperature



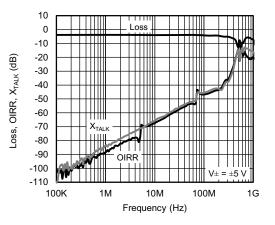
On-Resistance vs. Analog Voltage and Temperature



On-Resistance vs. V_D (Dual Supply Voltage)



On-Resistance vs. Analog Voltage and Temperature



Insertion Loss, Off-Isolation, Crosstalk vs. Frequency

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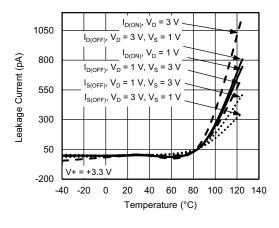
9

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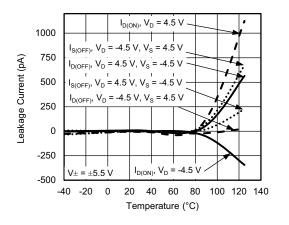
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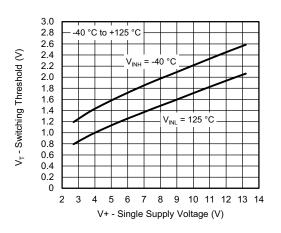
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



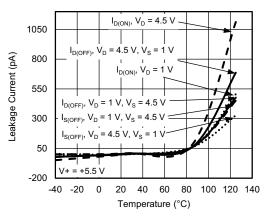
Leakage Current vs. Temperature



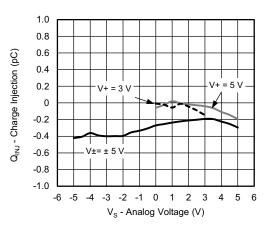
Leakage Current vs. Temperature



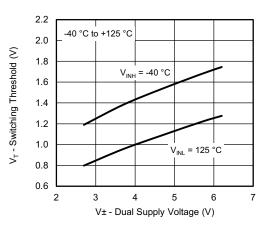
Switching Threshold vs. Supply Voltage



Leakage Current vs. Temperature



Charge Injection vs. Analog Voltage



Switching Threshold vs. Supply Voltage

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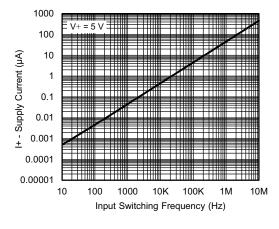
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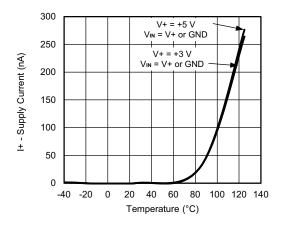
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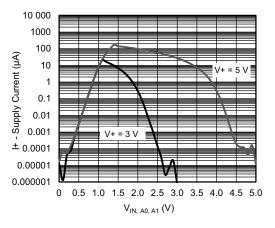
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



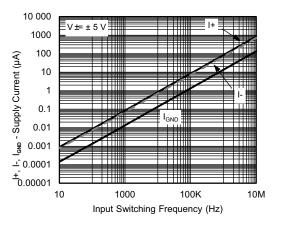
Supply Current vs. Switching Frequency



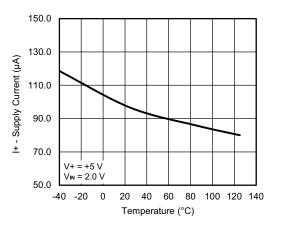
Supply Current vs. Temperature



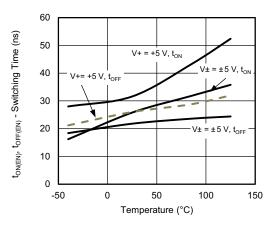
Supply Current vs. Enable Input Voltage



Supply Current vs. Switching Frequency



Supply Current vs. Temperature



Switching Time vs. Temperature

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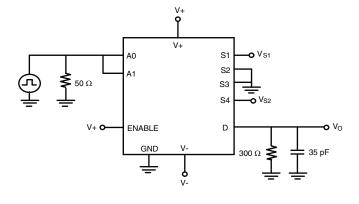
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TEST CIRCUITS



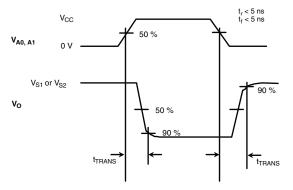
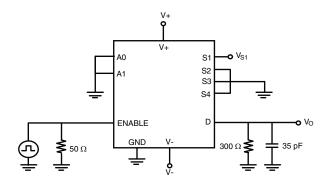
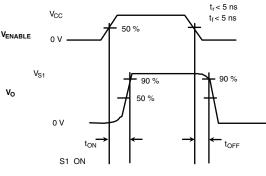
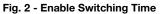
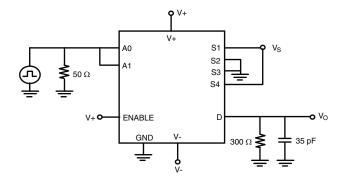


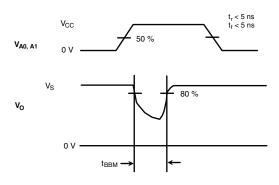
Fig. 1 - Transition Time











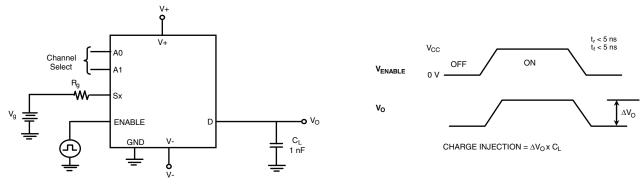


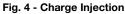
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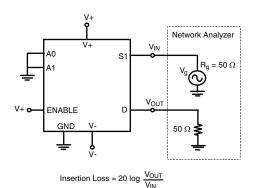


Fig. 5 - Insertion Loss

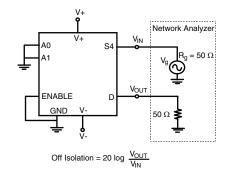


Fig. 6 - Off-Isolation

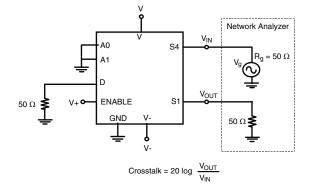
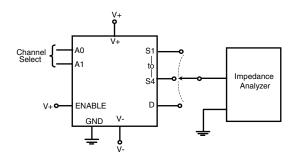


Fig. 7 - Crosstalk





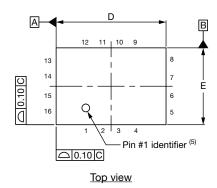
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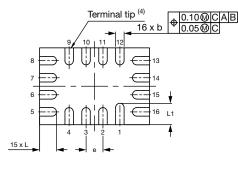
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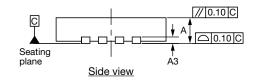


Thin miniQFN16 Case Outline





Bottom view



| DIMENSIONS | | MILLIMETERS ⁽¹⁾ | | | INCHES | | |
|-------------------|-----------|----------------------------|------|-----------|------------|-------|--|
| DIMENSIONS | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | |
| А | 0.50 | 0.55 | 0.60 | 0.020 | 0.022 | 0.024 | |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | |
| A3 | 0.15 ref. | | | | 0.006 ref. | | |
| b | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | 2.50 | 2.60 | 2.70 | 0.098 | 0.102 | 0.106 | |
| е | | 0.40 BSC | | 0.016 BSC | | | |
| E | 1.70 | 1.80 | 1.90 | 0.067 | 0.071 | 0.075 | |
| L | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 | |
| L1 | 0.45 | 0.50 | 0.55 | 0.018 | 0.020 | 0.022 | |
| N ⁽³⁾ | | 16 | | | 16 | | |
| Nd ⁽³⁾ | | 4 | | | 4 | | |
| Ne ⁽³⁾ | | 4 | | 4 | | | |

Notes

⁽¹⁾ Use millimeters as the primary measurement.

- ⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5M. 1994.
- ⁽³⁾ N is the number of terminals. Nd and Ne is the number of terminals in each D and E site respectively.

 $^{(4)}$ Dimensions b applies to plated terminal and is measured between 0.15 mm and 0.30 mm from terminal tip.

⁽⁵⁾ The pin 1 identifier must be existed on the top surface of the package by using identification mark or other feature of package body.

⁽⁶⁾ Package warpage max. 0.05 mm.

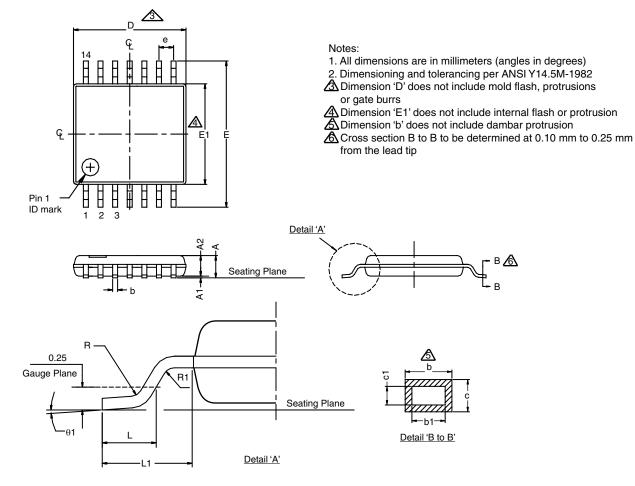
ECN: T16-0226-Rev. B, 09-May-16 DWG: 6023



Package Information

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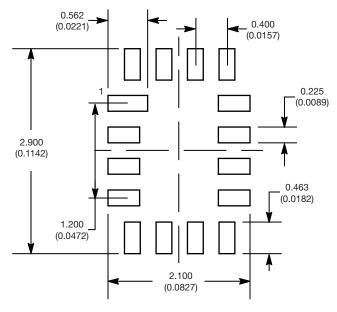
14L TSSOP



| SYMBOL | MINIMUM | NOMINAL | MAXIMUM |
|--------|---------|----------|---------|
| Α | - | - | 1.20 |
| A1 | 0.05 | - | 0.15 |
| A2 | 0.80 | 0.90 | 1.05 |
| D | 4.9 | 5.0 | 5.1 |
| E1 | 4.3 | 4.4 | 4.5 |
| E | 6.2 | 6.4 | 6.6 |
| L | 0.45 | 0.60 | 0.75 |
| R | 0.09 | - | - |
| R1 | 0.09 | - | - |
| b | 0.19 | - | 0.30 |
| b1 | 0.19 | 0.22 | 0.25 |
| С | 0.09 | - | 0.20 |
| c1 | 0.09 | - | 0.16 |
| θ1 | 0° | - | 8° |
| L1 | | 1.0 ref. | |
| е | | 0.65 BSC | |



RECOMMENDED MINIMUM PADS FOR MINI QFN 16L



Mounting Footprint Dimensions in mm (inch)



Vishay

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